

SCHOTTKY BARRIER DIODE

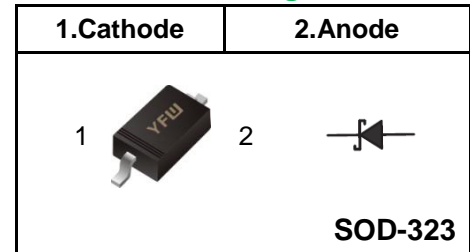
FEATURES

- ◆ Low Forward Voltage Drop
- ◆ Guard Ring Construction for Transient Protection
- ◆ Negligible Reverse Recovery Time
- ◆ Low Capacitance
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- ◆ Case: SOD-323
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 5.48mg / 0.00019oz

Pinning



Marking Code

SD103AWS	S4
SD103BWS	S5
SD103CWS	S6

Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter		Symbols	SD103AWS	SD103BWS	SD103CWS	Units
Peak Repetitive Reverse Voltage		V_{RRM}	40	30	20	V
RMS reverse voltage		V_{RMS}	28	21	14	V
Working Peak Reverse Voltage		V_{DC}	40	30	20	V
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed On Rated Load(JEDEC method)		I_{FSM}	13			A
Maximum Instantaneous Forward Voltage	$I_F=20mA$	V_F	0.37			V
	$I_F=200mA$		0.60			
Power Dissipation		P_D	200			mW
Reverse current	SD103AWS, $V_R=30V$	I_R	5	-	-	uA
	SD103BWS, $V_R=20V$		-	5	-	
	SD103CWS, $V_R=10V$		-	-	5	
Thermal Resistance, Junction to Ambient Air		$R_{\theta JA}$	300			°C/W
Reverse voltage $I_R=100uA$	SD103AWS	$V_{(BR)R}$	40			V
	SD103BWS		30			
	SD103CWS		20			
Reverse recovery time $I_F=I_R=200mA, I_{rr}=0.1 \times I_R, R_L=100\Omega$		T_{rr}	10			nS
Forward Continuons Current		I_{FM}	350			mA
Total capacitance $V_R=0V, f=1MHZ$		C_{tot}	50			pF
Junction temperature		T_j	125			°C
Storage temperature		T_{stg}	-55 ~ +150			°C

Fig.1 Power Derating Curve

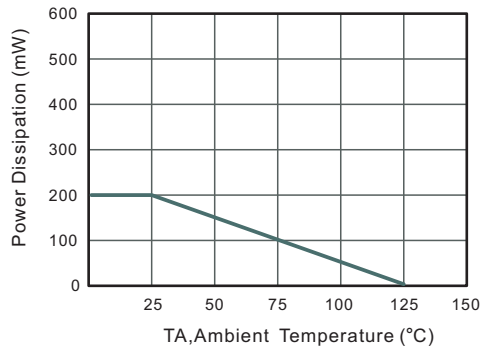


Fig.2 Typical Reverse Characteristics

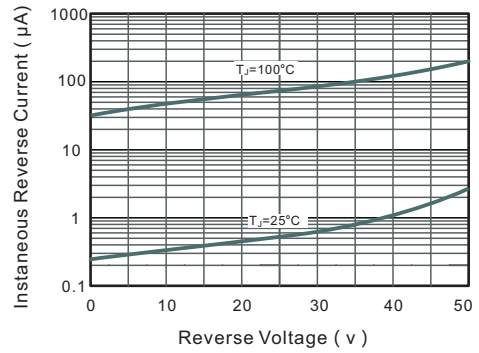


Fig.3 Forward Characteristics

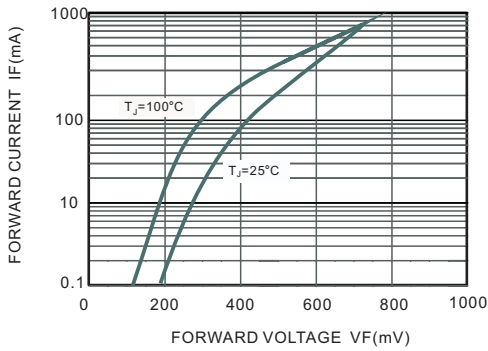


Fig.4 Maximum Non-Repetitive Peak Forward Surge Current

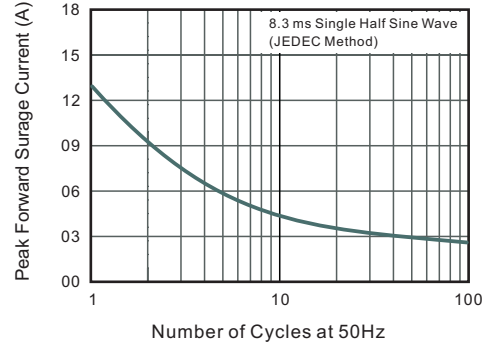


Fig.5 Typical Junction Capacitance

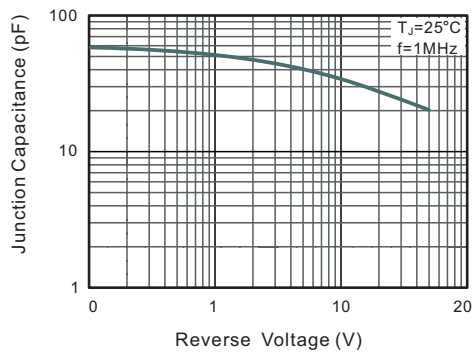
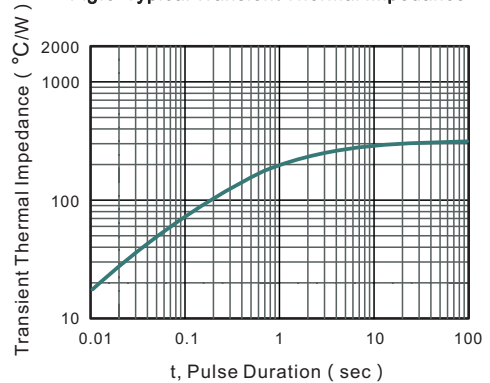


Fig.6 Typical Transient Thermal Impedance



Ordering information

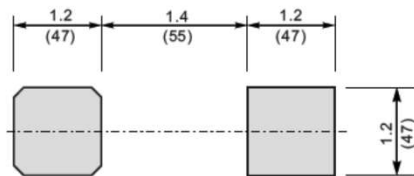
Package	Packing Description	Packing Quantity
SOD-323	Tape/Reel, 7" reel	3000PCS/Reel 120000PCS/Carton

Package Dimensions

SOD-323

Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.
A	0.8	1.1	32	43
C	0.08	0.15	3.1	5.9
D	1.2	1.4	47	55
E	1.4	1.8	63	70
E1	2.55	2.75	100	108
b	0.25	0.4	9.8	16
L1	0.2	0.45	7.9	16
A1	-	0.2	-	8
∠	9°			

The recommended mounting pad size



Unit: $\frac{\text{mm}}{\text{mil}}$

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